TOSHIBA CMOS DIGITAL INTEGRATED CIRCUIT SILICON MONOLITHIC

TC7W02F, TC7W02FU

DUAL 2-INPUT NOR GATE

The TC7W02 is a high speed C²MOS 2-INPUT NOR GATE fabricated with silicon gate C²MOS technology.

It achives the high speed operation similar to equivalent LSTTL while maintaining the C²MOS low power dissipation.

The internal circuit is composed of 3 stages including buffer output, which enables high noise immunity and stable output.

All inputs are equipped with protection circuits against static discharge or transient excess voltage.

FEATURES

•	High Speed	 	 $t_{pd} = 6ns$	(Typ.)	at
			$V_{CC} = 5V$		

• Low Power Dissipation
$$I_{CC} = 1\mu A$$
 (Max.) at $Ta = 25^{\circ}C$

$$= 28\% V_{CC} (Min.)$$

• Symmetrical Output Impedance ...
$$|I_{OH}| = I_{OL} = 4mA$$

(Min.)

• Balanced Propagation Delays $t_{pLH} = t_{pHL}$

• Wide Operating Voltage Range ... $V_{CC(opr)} = 2 \sim 6V$

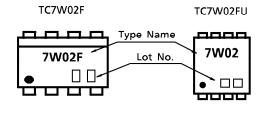
SOP8-P-1.27 TC7W02FU SSOP8-P-0.65

Weight SOP8-P-1.27 : 0.05g (Typ.) SSOP8-P-0.65 : 0.02g (Typ.)

MAXIMUM RATINGS (Ta = 25°C)

CHARACTERISTIC	SYMBOL	RATING	UNIT
Supply Voltage Range	Vcc	-0.5~7	V
DC Input Voltage	VIN	-0.5~V _{CC} + 0.5	V
DC Output Voltage	Vout	-0.5~V _{CC} + 0.5	V
Input Diode Current	ΙΚ	± 20	mA
Output Diode Current	loк	± 20	mA
DC Output Current	lout	± 25	mA
DC V _{CC} / Ground Current	lcc	± 25	mA
Power Dissipation	PD	300	mW
Storage Temperature	T _{stg}	-65~150	°C
Lead Temperature (10s)	TL	260	°C

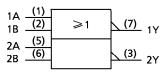
MARKING



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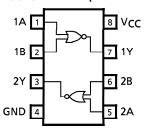
LOGIC DIAGRAM



TRUTH TABLE

Α	В	Υ
L	L	Н
L	Н	L
Н	L	L
Η	Η	L

PIN ASSIGNMENT (TOP VIEW)



RECOMMENDED OPERATING CONDITIONS

CHARACTERISTIC	SYMBOL	RATING	UNIT
Supply Voltage Range	Vcc	2~6	V
Input Voltage	V _{IN}	0~V _{CC}	٧
Output Voltage	Vout	0~V _{CC}	V
Operating Temperature	T _{opr}	- 40~85	°C
		$0\sim1000 \ (V_{CC}=2.0V)$	
Input Rise and Fall Time	t _r , t _f	$0 \sim 500 \ (V_{CC} = 4.5V)$	ns
		$0 \sim 400 \ (V_{CC} = 6.0V)$	

DC ELECTRICAL CHARACTERISTICS

CHARACTERISTIC	SYMBOL	TEST CONDITION VC			Т	a = 25°	Ď	Ta = -4	0∼85°C	UNIT
CHARACTERISTIC	STIVIBUL			Vcc	MIN.	TYP.	MAX.	MIN.	MAX.	UNIT
High-Level				2.0	1.5	_	_	1.5	_	
Input Voltage	VIH		_	4.5	3.15	_	—	3.15	_	V
input voitage				6.0	4.2	_	—	4.2	_	
Low-Level				2.0	_	_	0.5		0.5	
Input Voltage	VIL	_		4.5	—	—	1.35	_	1.35	V
input voitage				6.0	_	_	1.8	1	1.8	
		V _{IN} = V _{IL}		2.0	1.9	2.0	_	1.9	_	
I I i ala I accal	Voн		$I_{OH} = -20\mu A$	4.5	4.4	4.5	—	4.4	_	v
High-Level				6.0	5.9	6.0	—	5.9	_	
Output Voltage			I _{OH} = -4mA	4.5	4.18	4.31	—	4.13	_	
			$I_{OH} = -5.2 \text{mA}$	6.0	5.68	5.80	_	5.63	_	
		V _{IN} = V _{IH}		2.0	_	0.0	0.1	_	0.1	
Lave Lavel			$I_{OL} = 20 \mu A$	4.5	 	0.0	0.1	_	0.1	
Low-Level	VOL			6.0	_	0.0	0.1	-	0.1	V
Output Voltage		or V _{IL}	I _{OL} = 4mA	4.5	_	0.17	0.26		0.33	
			$I_{OL} = 5.2 \text{mA}$	6.0	_	0.18	0.26	1	0.33	
Input Leakage Current	IIN	V _{IN} = V _{CC} o	or GND	6.0	_	_	± 0.1	_	± 1.0	
Quiescent Supply Current	^I cc	$V_{IN} = V_{CC}$	or GND	6.0	_	_	1.0	_	10.0	μΑ

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AC ELECTRICAL CHARACTERISTICS ($C_L = 15pF$, $V_{CC} = 5V$, Ta = 25°C)

CHARACTERISTIC	SYMBOL	TEST CONDITION	Т	UNIT		
CHARACTERISTIC	STIVIBUL	TEST CONDITION	MIN.	TYP.	MAX.	UIVII
Output Transition	tTLH			4	۰	20
Time	tTHL	_		4	°	ns
Propagation Delay	t _{pLH}			6	12	20
Time	t _{pHL}	_	_		'2	ns

AC ELECTRICAL CHARACTERISTICS ($C_L = 50pF$, Input $t_r = t_f = 6ns$)

CHARACTERISTIC	SYMBOL	TEST CONDITION		Ta = 25°C			Ta = -4	UNIT	
CHARACTERISTIC	3 I IVIBOL	TEST CONDITION		MIN.	TYP.	MAX.	MIN.	MAX.	OIVII
Output Transition	t		2.0	_	25	75	_	95	
Time	t _{TLH}	_	4.5	 —	7	15	_	19	ns
Time	^t THL		6.0	—	6	13	—	16	
Dramagation Dalay	t _{pLH}	_	2.0	_	27	75	_	95	ns
Propagation Delay			4.5	 	9	15	<u> </u>	19	
Time	t _{pHL}		6.0	—	8	13	—	16	
Input Capacitance	CIN	_		_	5	10	_	10	
Power Dissipation Capacitance	C _{PD}	(Note 1)		_	21	_	_	_	pF

Note 1 : CpD is defined as the value of internal equivalent capacitance of IC which is calculated from the operating current consumption without load (refer to Test Circuit).

Average operating current can be obtained by the equation hereunder. $|CC(opr)| = CPD \cdot VCC \cdot f_{IN} + |CC|/2$ (per gate)